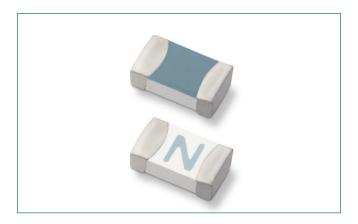
Ceramic Fuse > 438GT Series



# 438GT Series - 0603 Fast-Acting Fuse





## **Agency Approvals**

Agency	Agency File Number	Ampere Range
c <b>FL</b> °us	E10480	2A – 6A
<b>®</b> ;	29862	2A – 6A

## **Electrical Characteristics for Series**

% of Ampere Rating	Ampere Rating	Opening Time at 25°C	
100%	2A – 6A	4 Hours, Minimum	
250%	2A – 6A	5 Seconds, Maximum	

# **Description**

The 438GT Series is a 100% Lead-free, RoHS compliant and Halogen-free fuse series designed specifically to provide over-current protection to circuits that operate under high working ambient temperature up to 150°C.

The general design ensures excellent temperature stability and performance reliability.

The high I2t values which is typical in the Littelfuse Ceramic Fuse family ensure high inrush current withstand capability.

## **Features**

- Operating Temperature from -55°C to +150°C
- 100% Lead-free, RoHS compliant and Halogen-free
- Suitable for both leaded and lead-free reflow/ wave soldering
- Recognized to UL/CSA/ NMX 248-1 and UL/CSA/ NMX 248-14

# **Applications**

- · Handheld Electronics
- LCD Displays
- · Hard Disk Drives
- SD Memory Cards
- Battery Packs

# Additional Information



**Datasheet** 



Resources



Samples

# **Electrical Specifications by Item**

Ampere			Interrupting Rating (AC/DC) <sup>1</sup>	Resistance N	Nominal Melting l²t (A²Sec.) ³	Nominal Voltage Drop At Rated Current (V) <sup>4</sup>	Nominal Power Dissipation At Rated Current (W)	Agency Approvals	
Rating (A)	Amp Code							c <b>FL</b> °us	<b>(</b>
2	002.	32	50A @ 32VDC/12VAC	0.0490	0.181	0.110	0.220	Х	Х
2.5	02.5	32		0.0364	0.240	0.094	0.235	Х	Х
3	003.	32		0.0264	0.439	0.082	0.246	X	Х
3.5	03.5	32		0.0210	0.647	0.078	0.273	Х	Х
4	004.	32		0.0164	0.739	0.075	0.300	х	Х
5	005.	32		0.0127	0.747	0.072	0.360	Х	Х
6	006.	24	50A @ 24VDC/12VAC	0.0086	1.444	0.070	0.420	Х	Х

- 1. AC Interrupting Rating tested at rated voltage with unity power factor. DC Interrupting Rating tested at rated voltage with time constant <0.8 msec.

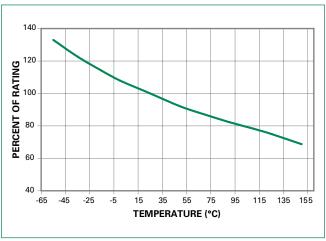
  2. Nominal Resistance measured with <10% rated current.
- 3. Nominal Melting I2t measured at 1msec. opening time.
- 4. Nominal Voltage Drop measured at rated current after temperature has stabilized.

Devices designed to carry rated current for 4 hours minimum. It is recommended that devices be operated continuously at no more than 80% rated current. See "Temperature Re-rating Curve" for additional re-rating

Devices designed to be mounted with marking code facing up.



# **Temperature Re-rating Curve**



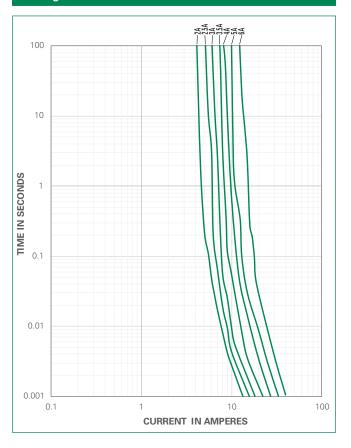
### Note:

Re-rating depicted in this curve is in addition to the standard re-rating of 20% for continuous operation.
 Example:

 For continuous operation at 75 degrees celsius, the fuse should be rerated as follows:

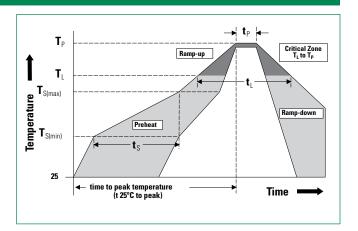
For continuous operation at 75 degrees celsius, the fuse should be rerated as follows:  $I = (0.80)(0.85)I_{BAT} = (0.68)I_{BAT}$ 

# **Average Time Current Curves**



# **Soldering Parameters**

Reflow Con	Reflow Condition		Pb – free assembly	
	- Temperature Min (T <sub>s(min)</sub> )		150°C	
Pre Heat	- Temperature Max (T <sub>s(max)</sub> )		200°C	
	-Time (Min to Max	-Time (Min to Max) (t <sub>s</sub> )		
Average Ra	Average Ramp-up Rate (Liquidus Temp (T <sub>L</sub> ) to peak)			
T <sub>S(max)</sub> to T <sub>L</sub>	Ramp-up Rate		5°C/second max.	
Reflow	- Temperature (T <sub>L</sub> ) (Liquidus)		217°C	
nellow	- Temperature (t <sub>L</sub> )		60 – 150 seconds	
Peak Tempe	Peak Temperature (T <sub>P</sub> )		260+0/-5 °C	
Time within	5°C of actual peak	Temperature (t <sub>p</sub> )	10 – 30 seconds	
Ramp-down	Ramp-down Rate		6°C/second max.	
Time 25°C to peak Temperature (T <sub>p</sub> )			8 minutes max.	
Do not exceed		260°C		
Wave Solde	Wave Soldering 260°C, 10 seconds in		nax.	



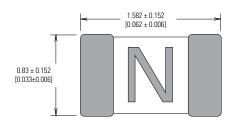
# **Surface Mount Fuses**

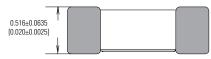
# **Product Characteristics**

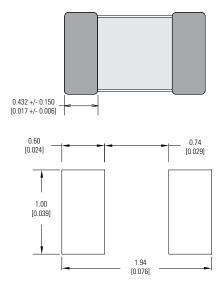
	Body: Advanced Ceramic
Materials	<b>Terminations:</b> Ag / Ni / Sn (100% Lead-free)
	Element Cover Coating: Lead-free Glass
Moisture Sensitivity Level	IPC/JEDEC J-STD-020, Level 1
Solderability	IPC/EIC/JEDEC J-STD-002, Condition B
Humidity	MIL-STD-202, Method 103, Conditions D
Resistance to Solder Heat	MIL-STD-202, Method 210, Condition B

Moisture Resistance	MIL-STD-202, Method 106	
Thermal Shock	MIL-STD-202, Method 107, Condition B-3	
Mechanical Shock	MIL-STD-202, Method 213, Condition A	
Vibration	MIL-STD-202, Method 201	
Vibration, High Frequency	MIL-STD-202, Method 204, Condition D	
Dissolution of Metallization	IPC/EIC/JEDEC J-STD-002, Condition D	
Terminal Strength	IEC 60127-4	

# **Dimensions**



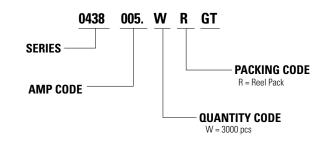




# Part Marking System

Amp Code	Marking Code
002.	N
02.5	0
003.	P
03.5	R
004.	S
005.	Т
006.	U

# **Part Numbering System**



# **Packaging**

Packaging Option Packaging Specification		Quantity	Quantity & Packaging Code
8mm Tape and Reel	EIA-481, IEC 60286, Part 3	3000	WR